

SN54LS323, SN74LS323 8-BIT UNIVERSAL SHIFT/STORAGE REGISTERS

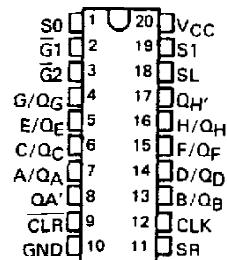
SDLS160

OCTOBER 1976 - REVISED MARCH 1988

- Multiplexed Inputs/Outputs Provide Improved Bit Density
- Four Modes of Operation:
 - Hold (Store) Shift Left
 - Shift Right Load Data
- Operates with Outputs Enabled or at High Z
- 3-State Outputs Drive Bus Lines Directly
- Can Be Cascaded for N-Bit Word Lengths
- Typical Power Dissipation . . . 175 mW
- Exceptionally Stable Shift (Clock) Frequency . . . 25 MHz
- Applications:
 - Stacked or Push-Down Registers, Buffer Storage, and Accumulator Registers
- SN54LS299 and SN74LS299 Are Similar But Have Direct Overriding Clear

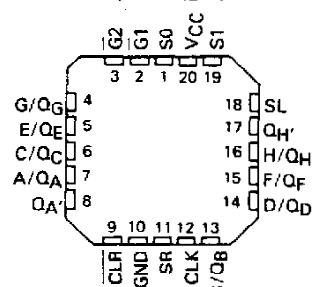
SN54LS323 . . . J OR W PACKAGE
SN74LS323 . . . DW OR N PACKAGE

(TOP VIEW)



SN54LS323 . . . FK PACKAGE

(TOP VIEW)



description

These Low-Power Schottky eight-bit universal registers feature multiplexed inputs/outputs to achieve full eight-bit data handling in a single 20-pin package. Two function-select inputs and two output-control inputs can be used to choose the modes of operation listed in the function table. Synchronous parallel loading is accomplished by taking both function-select lines, S0 and S1, high. This places the three-state outputs in a high-impedance state, which permits data that is applied on the input/output lines to be clocked into the register. Reading out of the register can be accomplished while the outputs are enabled in any mode. The clear function is synchronous, and a low level at the clear input clears the register on the next low-to-high transition of the clock.

FUNCTION TABLE

MODE	INPUTS								INPUTS/OUTPUTS								OUTPUTS	
	CLR	FUNCTION		OUTPUT		CLK	SERIAL	A/QA B/QB C/QC D/QD E/QE F/QF G/QG H/QH								QA' QH'		
		SELECT	CONTROL	G1 ^t	G2 ^t			QA0 QB0 QC0 QD0 QE0 QF0 QG0 QH0								QA0 QH0		
Clear	L	X	L	L	L	†	X X	L L L L L L L L	L L L L L L L L	L L L L	L L	L L	L L	L L	L L	L L	L L	
	L	L	X	L	L	†	X X	L L L L L L L L	L L L L L L L L	L L L L L L L L	L L L L	L L L L	L L L L	L L L L	L L L L	L L L L	L L L L	
	L	H	H	X	X	†	X X	X X X X X X X X	X X X X X X X X	X X X X X X X X	X X X X X X X X	X X X X X X X X	X X X X X X X X	X X X X X X X X	X X X X X X X X	X X X X X X X X	X X X X X X X X	
Hold	H	L	L	L	L	X	X X	QA0 QA0 QC0 QC0 QE0 QE0 QF0 QF0	QA0 QA0 QC0 QC0 QE0 QE0 QF0 QF0	QA0 QA0 QC0 QC0 QE0 QE0 QF0 QF0	QA0 QA0 QC0 QC0 QE0 QE0 QF0 QF0	QA0 QA0 QC0 QC0 QE0 QE0 QF0 QF0	QA0 QA0 QC0 QC0 QE0 QE0 QF0 QF0	QA0 QA0 QC0 QC0 QE0 QE0 QF0 QF0	QA0 QA0 QC0 QC0 QE0 QE0 QF0 QF0	QA0 QA0 QC0 QC0 QE0 QE0 QF0 QF0	QA0 QA0 QC0 QC0 QE0 QE0 QF0 QF0	
	H	X	X	L	L	L	X X	QA0 QA0 QC0 QC0 QE0 QE0 QF0 QF0	QA0 QA0 QC0 QC0 QE0 QE0 QF0 QF0	QA0 QA0 QC0 QC0 QE0 QE0 QF0 QF0	QA0 QA0 QC0 QC0 QE0 QE0 QF0 QF0	QA0 QA0 QC0 QC0 QE0 QE0 QF0 QF0	QA0 QA0 QC0 QC0 QE0 QE0 QF0 QF0	QA0 QA0 QC0 QC0 QE0 QE0 QF0 QF0	QA0 QA0 QC0 QC0 QE0 QE0 QF0 QF0	QA0 QA0 QC0 QC0 QE0 QE0 QF0 QF0	QA0 QA0 QC0 QC0 QE0 QE0 QF0 QF0	
Shift Right	H	L	H	L	L	†	X	H H QAn QBn QCn QDn QEEn QFn QGn	H H QAn QBn QCn QDn QEEn QFn QGn	H H QAn QBn QCn QDn QEEn QFn QGn	H H QAn QBn QCn QDn QEEn QFn QGn	H H QAn QBn QCn QDn QEEn QFn QGn	H H QAn QBn QCn QDn QEEn QFn QGn	H H QAn QBn QCn QDn QEEn QFn QGn	H H QAn QBn QCn QDn QEEn QFn QGn	H H QAn QBn QCn QDn QEEn QFn QGn	H H QAn QBn QCn QDn QEEn QFn QGn	
	H	L	H	L	L	†	X	L QAn QBn QCn QDn QEEn QFn QGn	L QAn QBn QCn QDn QEEn QFn QGn	L QAn QBn QCn QDn QEEn QFn QGn	L QAn QBn QCn QDn QEEn QFn QGn	L QAn QBn QCn QDn QEEn QFn QGn	L QAn QBn QCn QDn QEEn QFn QGn	L QAn QBn QCn QDn QEEn QFn QGn	L QAn QBn QCn QDn QEEn QFn QGn	L QAn QBn QCn QDn QEEn QFn QGn	L QAn QBn QCn QDn QEEn QFn QGn	
Shift Left	H	H	L	L	L	†	H X	QBn QCn QDn QEEn QFn QGn QHn H	QBn QCn QDn QEEn QFn QGn QHn H	QBn QCn QDn QEEn QFn QGn QHn H	QBn QCn QDn QEEn QFn QGn QHn H	QBn QCn QDn QEEn QFn QGn QHn H	QBn QCn QDn QEEn QFn QGn QHn H	QBn QCn QDn QEEn QFn QGn QHn H	QBn QCn QDn QEEn QFn QGn QHn H	QBn QCn QDn QEEn QFn QGn QHn H	QBn QCn QDn QEEn QFn QGn QHn H	
	H	H	L	L	L	†	L X	QBn QCn QDn QEEn QFn QGn QHn L	QBn QCn QDn QEEn QFn QGn QHn L	QBn QCn QDn QEEn QFn QGn QHn L	QBn QCn QDn QEEn QFn QGn QHn L	QBn QCn QDn QEEn QFn QGn QHn L	QBn QCn QDn QEEn QFn QGn QHn L	QBn QCn QDn QEEn QFn QGn QHn L	QBn QCn QDn QEEn QFn QGn QHn L	QBn QCn QDn QEEn QFn QGn QHn L	QBn QCn QDn QEEn QFn QGn QHn L	
Load	H	H	H	X	X	†	X X	a b c d e f g h	a b c d e f g h	a b c d e f g h	a b c d e f g h	a b c d e f g h	a b c d e f g h	a b c d e f g h	a b c d e f g h	a b c d e f g h	a b c d e f g h	

^tWhen one or both output controls are high the eight input/output terminals are disabled to the high-impedance state; however, sequential operation or clearing of the register is not affected.

a . . . h = the level of the steady-state input at inputs A through H, respectively. These data are loaded into the flip-flops while the flip-flop outputs are isolated from the input/output terminals.

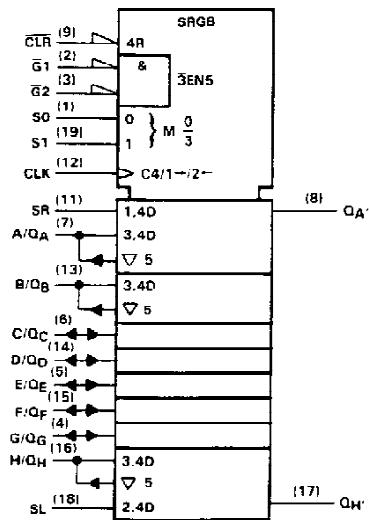
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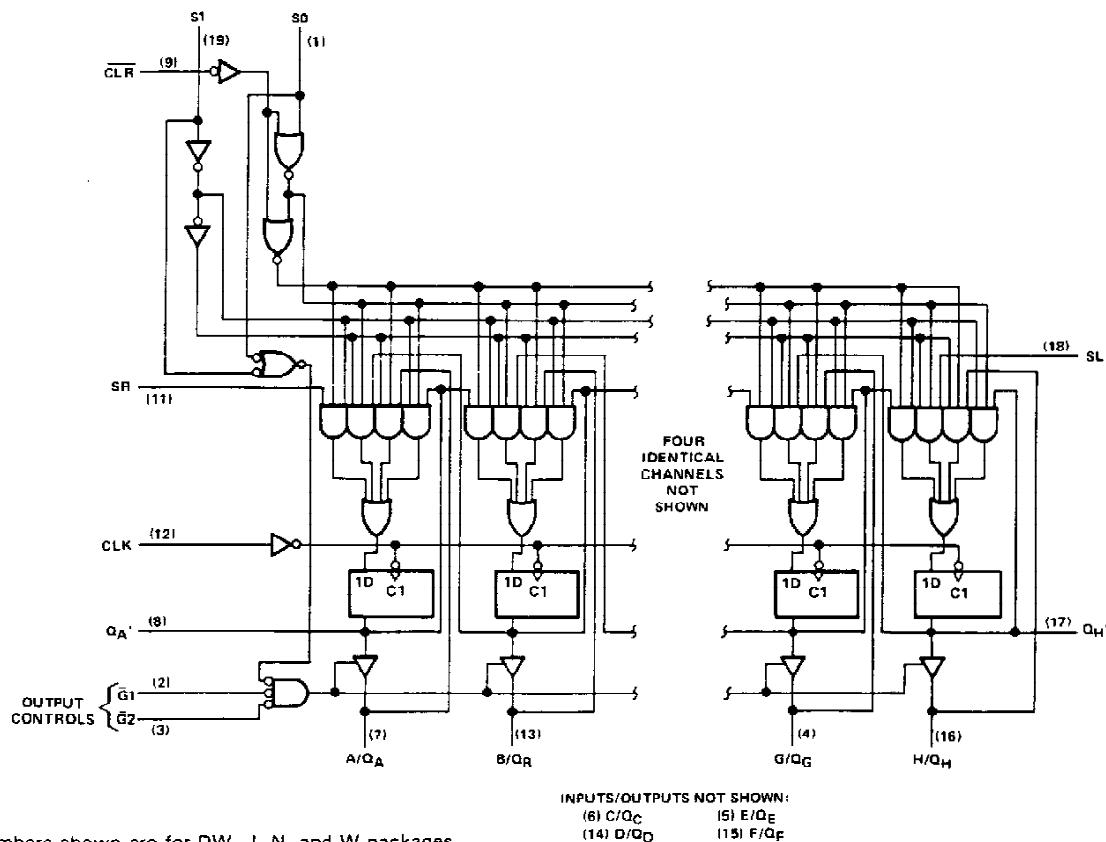
SN54LS323, SN74LS323 8-BIT UNIVERSAL SHIFT/STORAGE REGISTERS

logic symbol[†]



[†]This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.
Pin numbers shown are for DW, J, N, and W packages.

logic diagram (positive logic)



TEXAS
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SN54LS323, SN74LS323
8-BIT UNIVERSAL SHIFT/STORAGE REGISTERS

schematics of inputs and outputs, absolute maximum ratings, recommended operating conditions, and electrical characteristics

Same as SN54LS299 and SN74LS299, except t_{SU} (Clear Inactive) does not apply.

switching characteristics, $V_{CC} = 5$ V, $T_A = 25^\circ C$

PARAMETER [†]	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f_{max}			See Note 1	25	35		MHz
t_{PLH}	CLK	Q_A' or Q_H'	$C_L = 15 \text{ pF}, R_L = 2 \text{ k}\Omega$	22	33		
t_{PHL}				26	39		ns
t_{PLH}	CLK	Q_A thru Q_H	$C_L = 45 \text{ pF}, R_L = 665 \Omega$	17	25		
t_{PHL}				25	39		ns
t_{PZH}	\bar{G}_1, \bar{G}_2	Q_A thru Q_H	$C_L = 5 \text{ pF}, R_L = 665 \Omega$	14	21		
t_{PZL}				20	30		ns
t_{PHZ}	\bar{G}_1, \bar{G}_2	Q_A thru Q_H	$C_L = 5 \text{ pF}, R_L = 665 \Omega$	10	20		
t_{PLZ}				10	15		ns

[†] t_{max} = maximum clock frequency

t_{PLH} = Propagation delay time, low-to-high-level output

t_{PHL} = Propagation delay time, high-to-low-level output

t_{PZH} = Output enable time to high level

t_{PZL} = Output enable time to low level

t_{PHZ} = Output disable time from high level

t_{PLZ} = Output disable time from low level

NOTE 1: For testing f_{max} , all outputs are loaded simultaneously, each with C_L and R_L as specified for the propagation times. Load circuits and voltage waveforms are shown in Section 1.

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PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
SN54LS323J	Active	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54LS323J
SN54LS323J.A	Active	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54LS323J
SN54LS323J.A	Active	Production	CDIP (J) 20	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54LS323J
SNJ54LS323FK	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54LS 323FK
SNJ54LS323FK	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54LS 323FK
SNJ54LS323FK.A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54LS 323FK
SNJ54LS323FK.A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54LS 323FK

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

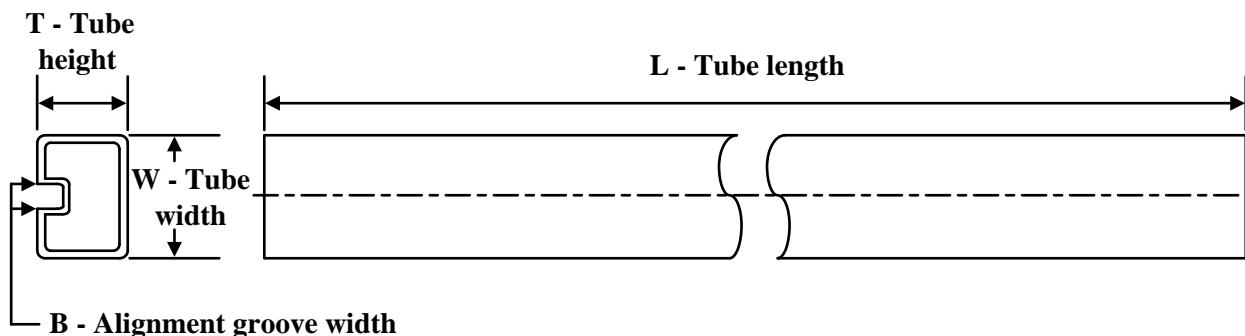
⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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TUBE


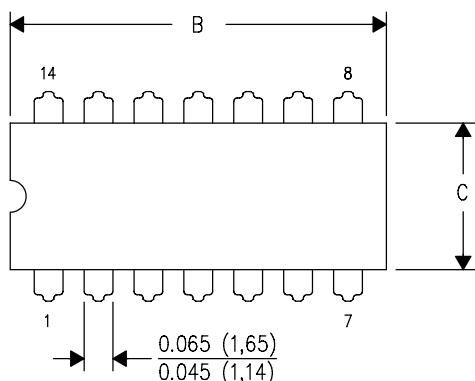
*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μ m)	B (mm)
SNJ54LS323FK	FK	LCCC	20	55	506.98	12.06	2030	NA
SNJ54LS323FK.A	FK	LCCC	20	55	506.98	12.06	2030	NA

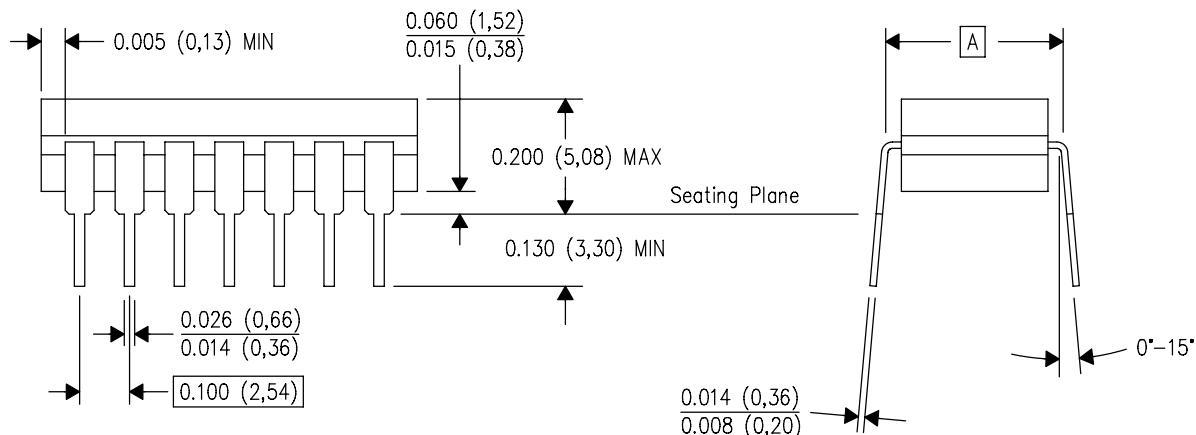
J (R-GDIP-T**)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



PINS ** DIM	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



4040083/F 03/03

NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package is hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

GENERIC PACKAGE VIEW

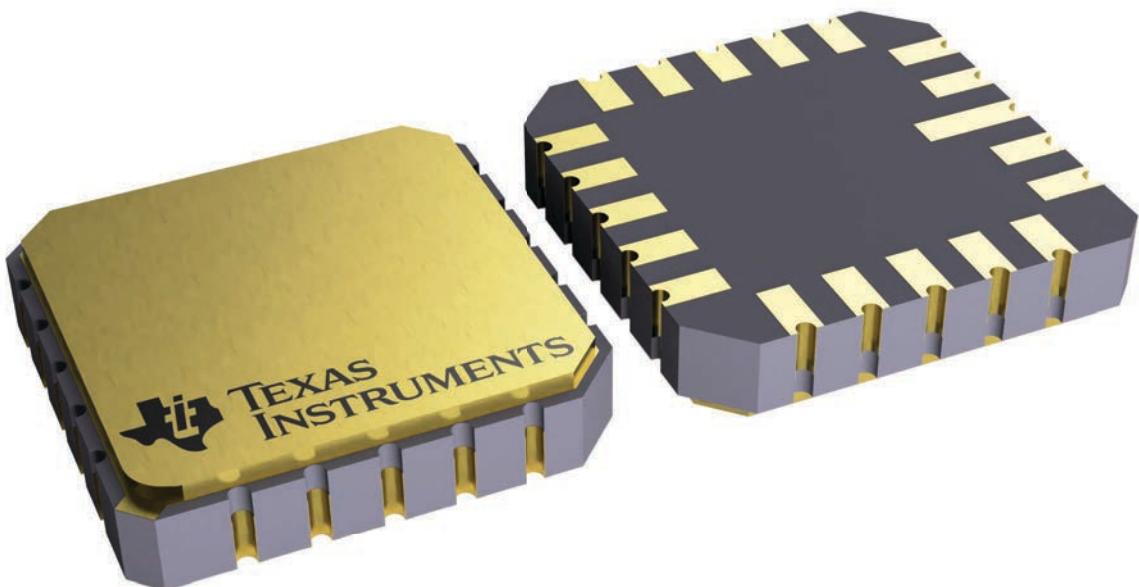
FK 20

LCCC - 2.03 mm max height

8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.



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